AMENDMENTS TO THE SPECIFICATION

Please amend the following paragraph, which is shown on p. 1, ln. 6-9, of the original specification, as follows:

The present invention relates to compositions for cutting off heat rays, and more particularly, to compositions for cutting off heat rays (while with being compatible with a hydrolic (aqueous) resin binder, an or-alcoholic resin binder, or and anti-hydrolic (non-aqueous) resin binder), films formed therefrom, and methods of forming them.

Please amend the following paragraph, which is shown on p. 4, ln. 16-19, of the original specification, as follows:

An object of the present invention is directed—to provide a heat-ray cutoff compound having a high transmission rate <u>for visible light while exhibiting and</u> an improved property of cutting off heat rays and a method of forming the same by means of <u>utilizing</u> conductive nanoparticles that <u>are is</u>-effective in cutting off heat rays.

Please amend the following paragraph, which is shown on p. 13, ln. 7-9, of the original specification, as follows:

There are a variety of ways to coating a compound characterized <u>for in</u> screening heat rays, such as spinal coating, deep coating, roll coating, bar coating, screen printing, photogravure, microgravure, offset, and so on.

2

U.S. Application No. 10/521,025 Atty. Dkt. No. 8947-000122/US

Please amend the following paragraph, which is shown on p. 15, ln. 2-3, of the original specification, as follows:

Pencil hardening intensity (pencil hardness) was measured on the standard of JIS K5651-1966.